
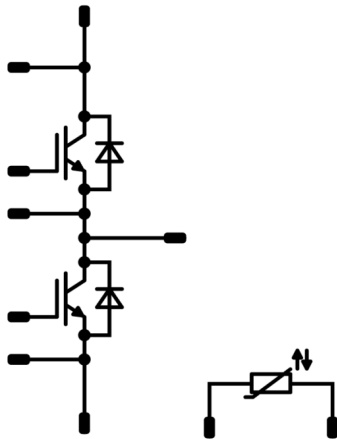




Vincotech

# A0-VS122PA690M7-L750F70 A0-VP122PA690M7-L750F70T

datasheet

VINcoDUAL E3		1200 V / 690 A
<b>Features</b> <ul style="list-style-type: none"> <li>• IGBT M7 technology with low <math>V_{CEsat}</math> and improved EMC behavior</li> <li>• New SoLid Cover Technology for higher reliability</li> <li>• Industry standard housing</li> <li>• Press-fit pin and pre-applied phase-change Thermal Interface Material available</li> </ul>		<b>VINco E3 housing</b> 
<b>Target applications</b> <ul style="list-style-type: none"> <li>• Industrial Drives</li> <li>• Power Supply</li> <li>• UPS</li> </ul>		<b>Schematic</b> 
<b>Types</b> <ul style="list-style-type: none"> <li>• A0-VS122PA690M7-L750F70</li> <li>• A0-VP122PA690M7-L750F70T</li> </ul>		

## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Half-Bridge Switch</b>				
Collector-emitter voltage	$V_{CES}$		1200	V
Collector current	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	681	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	1380	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	2065	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Maximum junction temperature	$T_{jmax}$		175	°C



Vincotech

**A0-VS122PA690M7-L750F70**  
**A0-VP122PA690M7-L750F70T**  
datasheet

## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Half-Bridge Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Continuous (direct) forward current	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	546	A
Repetitive peak forward current	$I_{FRM}$		1500	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	1357	W
Maximum junction temperature	$T_{jmax}$		175	°C

## Module Properties

### Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{jop}$		-40...( $T_{jmax} - 25$ )	°C

### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
		AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			18,1	mm
Clearance			16,2	mm
Comparative Tracking Index	CTI		> 200	

\* 100 % tested in production



Vincotech

**A0-VS122PA690M7-L750F70**  
**A0-VP122PA690M7-L750F70T**  
 datasheet

## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Half-Bridge Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{CE}$			0,069	25	5,4	6	6,6	V
Collector-emitter saturation voltage	$V_{CEsat}$		15		690	25 125 150		1,54 1,74 1,80	1,9	V
Collector-emitter cut-off current*	$I_{CES}$		0	1200		25			1140	μA
Gate-emitter leakage current	$I_{GES}$		20	0		25			1500	nA
Internal gate resistance	$r_g$							0,66		Ω
Input capacitance	$C_{ies}$		0	10		25		132000		pF
Output capacitance	$C_{oes}$							3900		
Reverse transfer capacitance	$C_{res}$							1590		
Gate charge	$Q_g$		±15	600	690	25		4200		nC

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4$ W/mK						0,08		K/W
-------------------------------------	---------------	---	--	--	--	--	--	------	--	-----

#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 1 \Omega$ $R_{gon} = 1 \Omega$	±15	600	690	25 125 150		533 554 543		ns
Rise time	$t_r$					25 125 150		77 93 94		
Turn-off delay time	$t_{d(off)}$					25 125 150		423 454 467		
Fall time	$t_f$					25 125 150		66 88 94		
Turn-on energy (per pulse)	$E_{on}$	$Q_{tFWD} = 58,4 \mu C$ $Q_{tFWD} = 101,2 \mu C$ $Q_{tFWD} = 103,3 \mu C$				25 125 150		57,701 81,075 84,463		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125 150		47,439 65,030 59,995		

\* Including parallel device's leakage current



Vincotech

**A0-VS122PA690M7-L750F70**  
**A0-VP122PA690M7-L750F70T**  
 datasheet

## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Half-Bridge Diode

#### Static

Forward voltage	$V_F$				750	25 125		1,70 1,87	2,2	V
Reverse leakage current	$I_R$			1200		25			450	μA

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4$ W/mK						0,11		K/W
-------------------------------------	---------------	---	--	--	--	--	--	------	--	-----

#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt = 9239$ A/μs $di/dt = 7628$ A/μs $di/dt = 11475$ A/μs	$\pm 15$	600	690	25 125 150		458 503 515		A
Reverse recovery time	$t_{rr}$					25 125 150		304 489 484		ns
Recovered charge	$Q_r$					25 125 150		58,419 101,163 103,293		μC
Reverse recovered energy	$E_{rec}$					25 125 150		22,897 41,652 36,651		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		3971 3040 2809		A/μs

### Thermistor

Rated resistance	$R$					25		5		kΩ
Deviation of $R_{100}$	$\Delta_{R/R}$	$R_{100} = 493 \Omega$				100	-5		+5	%
Power dissipation	$P$					25		245		mW
Power dissipation constant						25		1,4		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 2$ %				25		3375		K
B-value	$B_{(25/100)}$	Tol. $\pm 2$ %				25		3437		K
Vincotech NTC Reference									K	



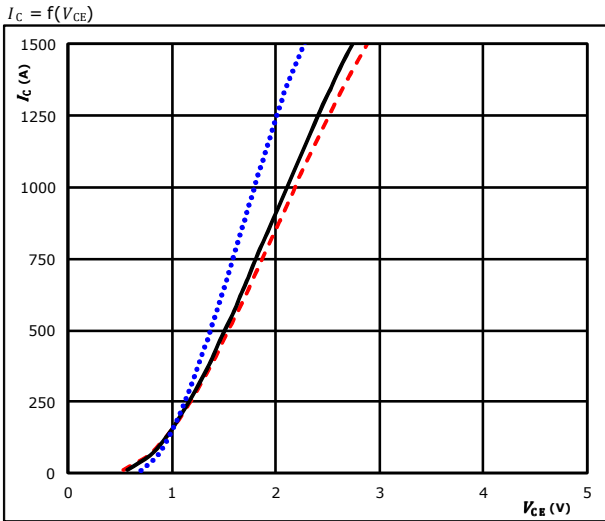
Vincotech

# A0-VS122PA690M7-L750F70 A0-VP122PA690M7-L750F70T datasheet

## Half-Bridge Switch Characteristics

**figure 1.** IGBT

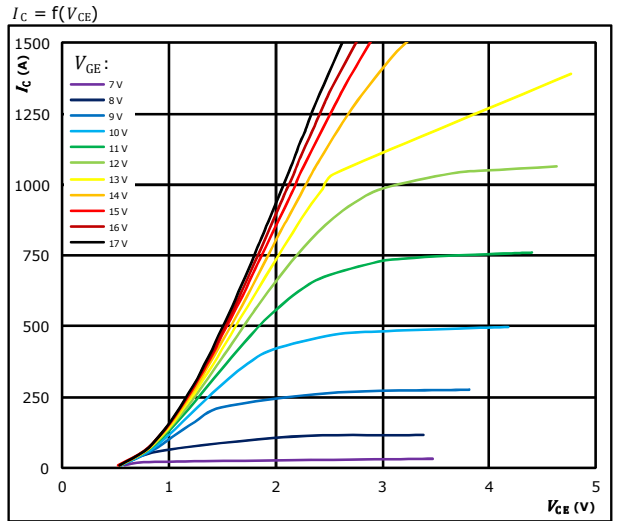
Typical output characteristics



$t_p = 250 \mu s$   
 $V_{GE} = 15 V$   
 $T_j: 25 \text{ } ^\circ C$  (blue dotted line)  
 $125 \text{ } ^\circ C$  (black solid line)  
 $150 \text{ } ^\circ C$  (red dashed line)

**figure 2.** IGBT

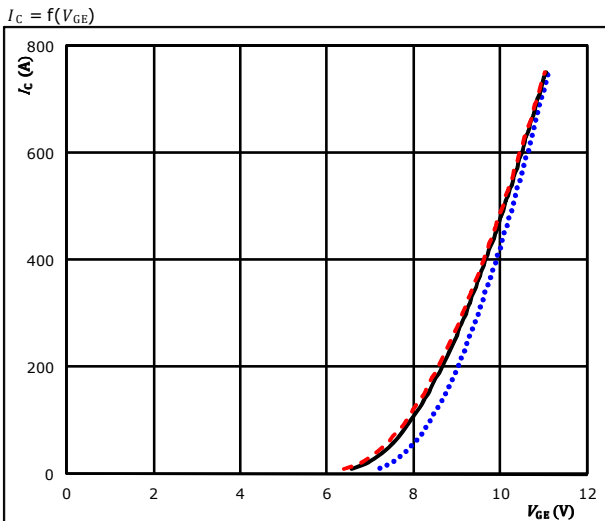
Typical output characteristics



$t_p = 250 \mu s$   
 $T_j = 125 \text{ } ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 3.** IGBT

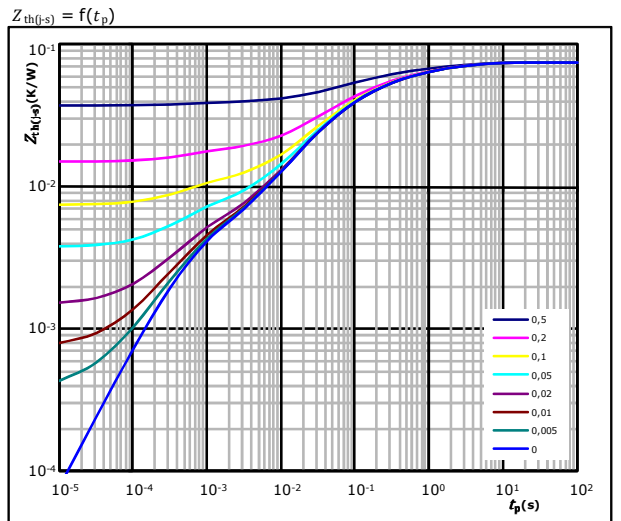
Typical transfer characteristics



$t_p = 100 \mu s$   
 $V_{CE} = 0 V$   
 $T_j: 25 \text{ } ^\circ C$  (blue dotted line)  
 $125 \text{ } ^\circ C$  (black solid line)  
 $150 \text{ } ^\circ C$  (red dashed line)

**figure 4.** IGBT

Transient thermal impedance as function of pulse duration



$D = t_p / T$   
 $R_{th(j-s)} = 0,08 \text{ K/W}$

IGBT thermal model values

$R$ (K/W)	$\tau$ (s)
8,90E-03	3,34E+00
1,87E-02	6,14E-01
2,40E-02	1,17E-01
1,80E-02	2,74E-02
1,75E-03	5,18E-03
3,56E-03	5,36E-04



Vincotech

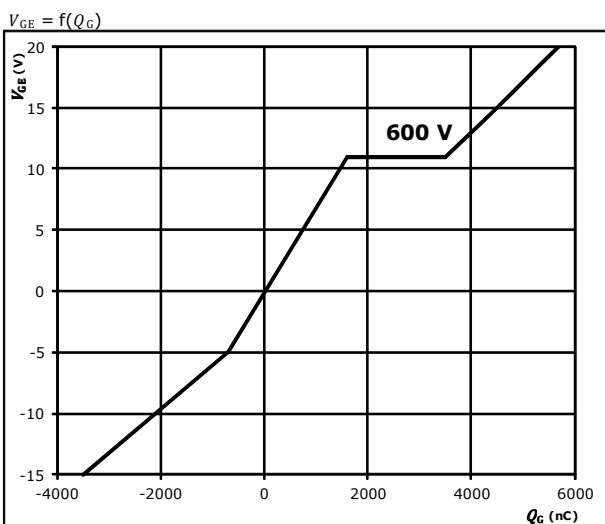
**A0-VS122PA690M7-L750F70**  
**A0-VP122PA690M7-L750F70T**  
 datasheet

## Half-Bridge Switch Characteristics

**figure 5.**

IGBT

Gate voltage vs gate charge

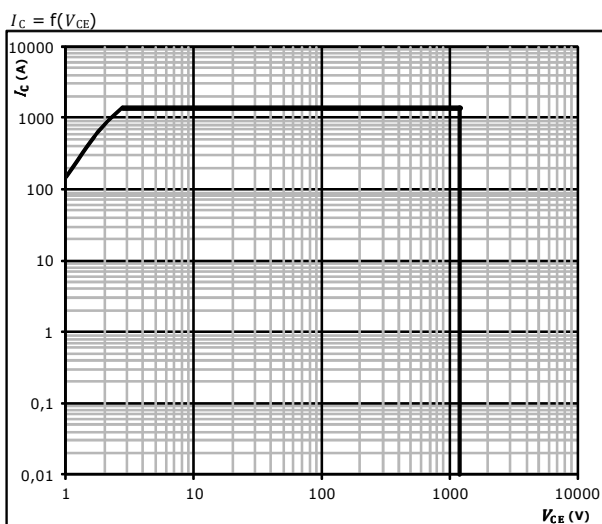


$I_C = 690$  A  
 $V_{GE} = \pm 15$  V  
 $V_{CC} = 600$  V

**figure 6.**

IGBT

Safe operating area



$D =$  single pulse  
 $T_s = 80$  °C  
 $V_{GE} = \pm 15$  V  
 $T_j = T_{jmax}$



Vincotech

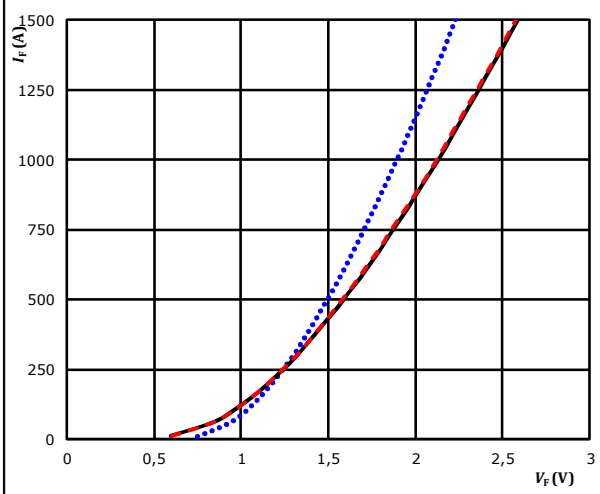
# A0-VS122PA690M7-L750F70 A0-VP122PA690M7-L750F70T datasheet

## Half-Bridge Diode Characteristics

**figure 1.** FWD

Typical forward characteristics

$$I_F = f(V_F)$$

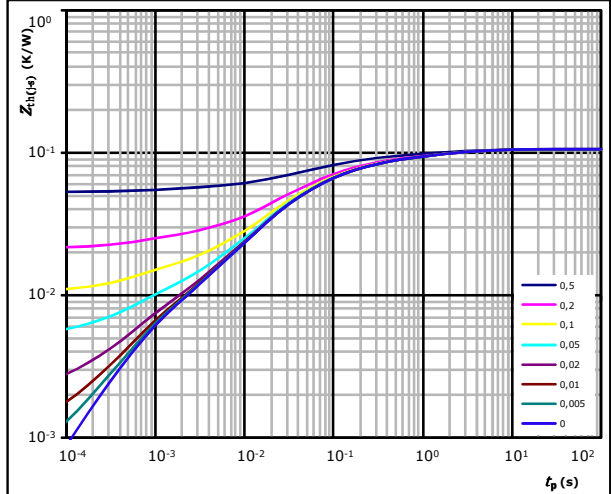


$t_p = 250 \mu s$   
 $T_j$ : 25 °C (blue dotted line)  
125 °C (black solid line)  
150 °C (red dashed line)

**figure 2.** FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0,11 \text{ K/W}$   
FWD thermal model values  

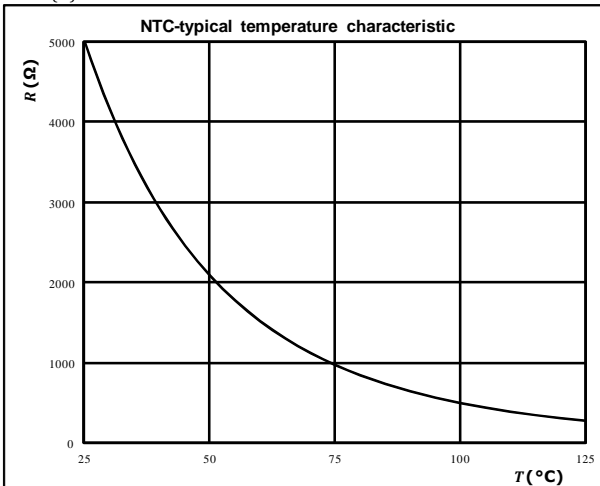
$R \text{ (K/W)}$	$\tau \text{ (s)}$
7,34E-03	4,93E+00
1,58E-02	1,02E+00
2,83E-02	1,62E-01
3,34E-02	4,06E-02
1,57E-02	1,26E-02
5,48E-03	7,94E-04

## Thermistor Characteristics

**figure 1.** Thermistor

Typical NTC characteristic  
as a function of temperature

$$R = f(T)$$





Vincotech

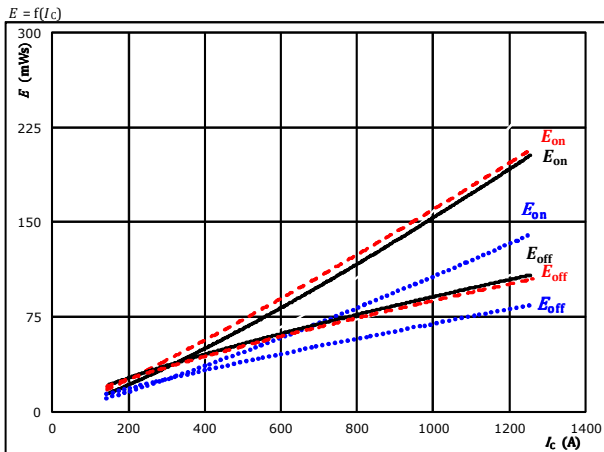
# A0-VS122PA690M7-L750F70 A0-VP122PA690M7-L750F70T

datasheet

## Half-Bridge Switching Characteristics

**figure 1.** IGBT

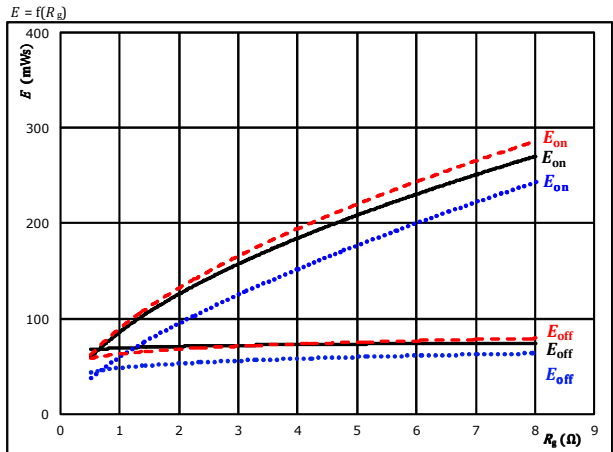
Typical switching energy losses as a function of collector current



With an inductive load at  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 1$   $\Omega$   
 $R_{goff} = 1$   $\Omega$   
 $T_J$ : 25 °C (dotted blue), 125 °C (solid black), 150 °C (dashed red)

**figure 2.** IGBT

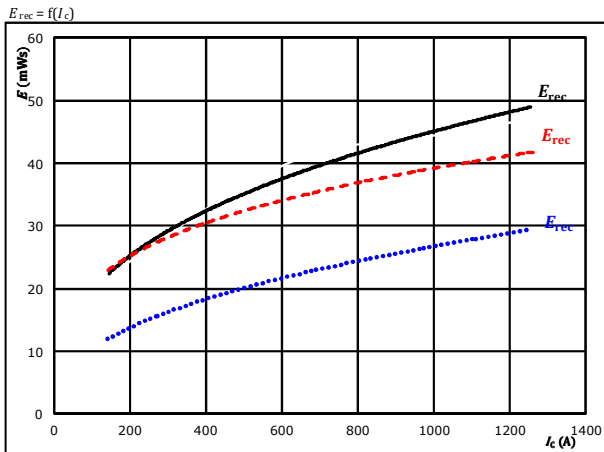
Typical switching energy losses as a function of gate resistor



With an inductive load at  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 690$  A  
 $T_J$ : 25 °C (dotted blue), 125 °C (solid black), 150 °C (dashed red)

**figure 3.** FWD

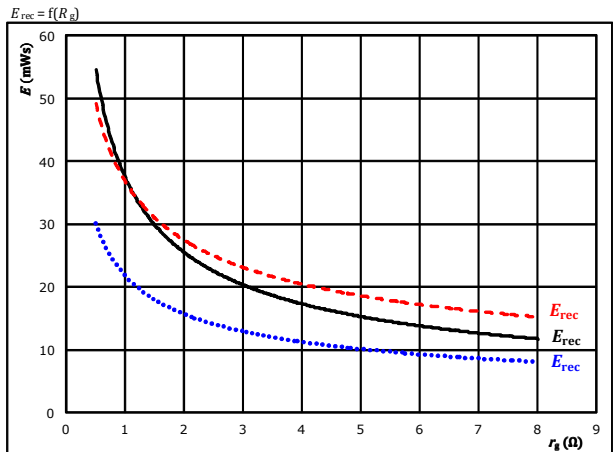
Typical reverse recovered energy loss as a function of collector current



With an inductive load at  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 1$   $\Omega$   
 $T_J$ : 25 °C (dotted blue), 125 °C (solid black), 150 °C (dashed red)

**figure 4.** FWD

Typical reverse recovered energy loss as a function of gate resistor



With an inductive load at  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 690$  A  
 $T_J$ : 25 °C (dotted blue), 125 °C (solid black), 150 °C (dashed red)



Vincotech

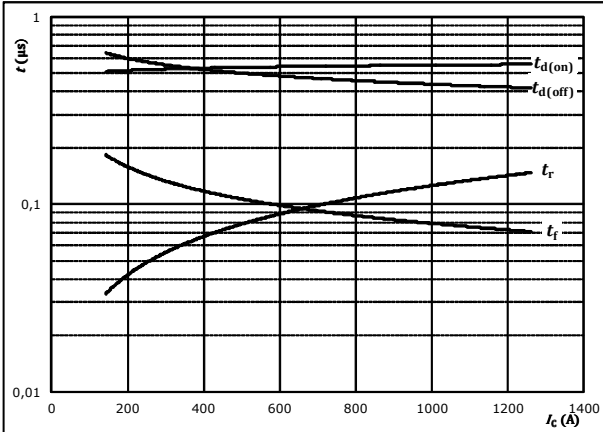
**A0-VS122PA690M7-L750F70**  
**A0-VP122PA690M7-L750F70T**  
datasheet

## Half-Bridge Switching Characteristics

**figure 5.** IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



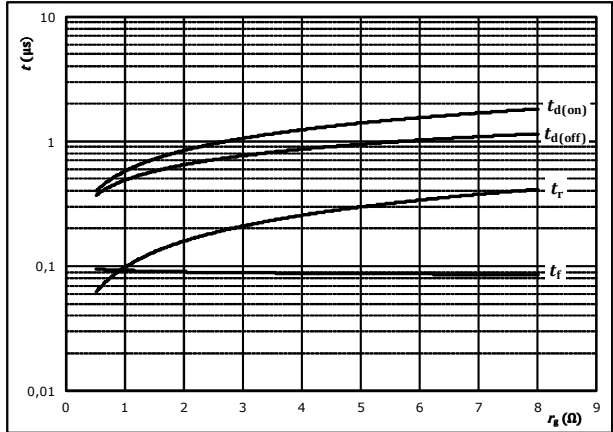
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	1	Ω
$R_{goff} =$	1	Ω

**figure 6.** IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



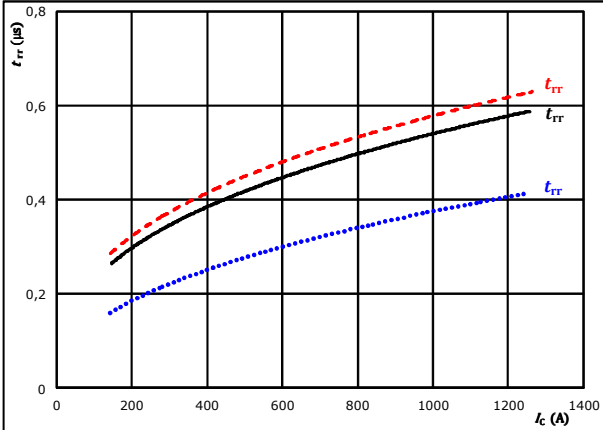
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	690	A

**figure 7.** FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$

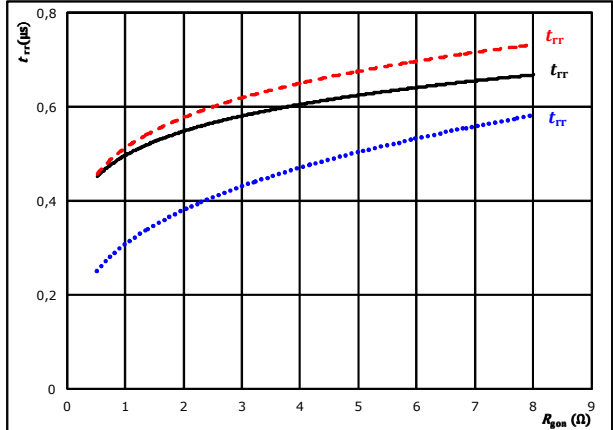


At	$V_{CE} =$	600	V	$T_j:$	25 °C	.....
	$V_{GE} =$	±15	V		125 °C	————
	$R_{gon} =$	1	Ω		150 °C	-----

**figure 8.** FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At	$V_{CE} =$	600	V	$T_j:$	25 °C	.....
	$V_{GE} =$	±15	V		125 °C	————
	$I_C =$	690	A		150 °C	-----



Vincotech

# A0-VS122PA690M7-L750F70 A0-VP122PA690M7-L750F70T

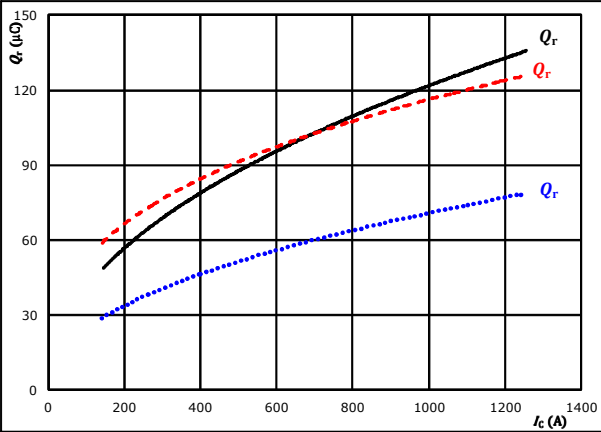
datasheet

## Half-Bridge Switching Characteristics

figure 9. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$

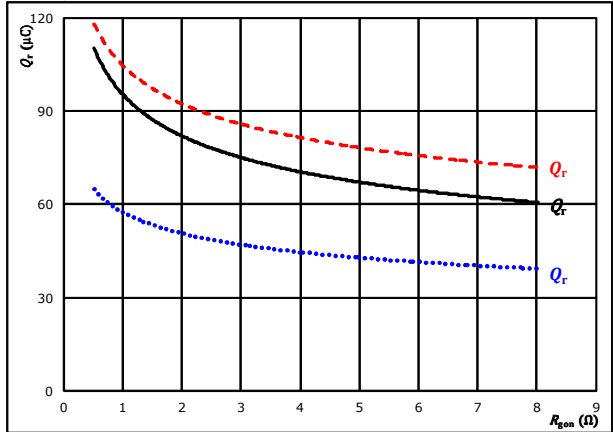


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 1$   $\Omega$   
 $T_j$ : 25 °C (dotted blue)  
125 °C (solid black)  
150 °C (dashed red)

figure 10. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$

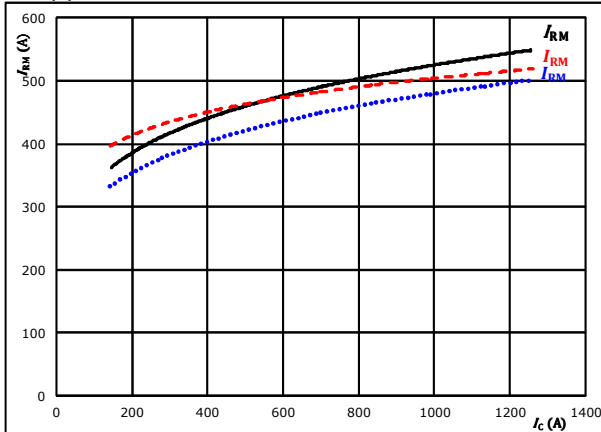


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 690$  A  
 $T_j$ : 25 °C (dotted blue)  
125 °C (solid black)  
150 °C (dashed red)

figure 11. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$

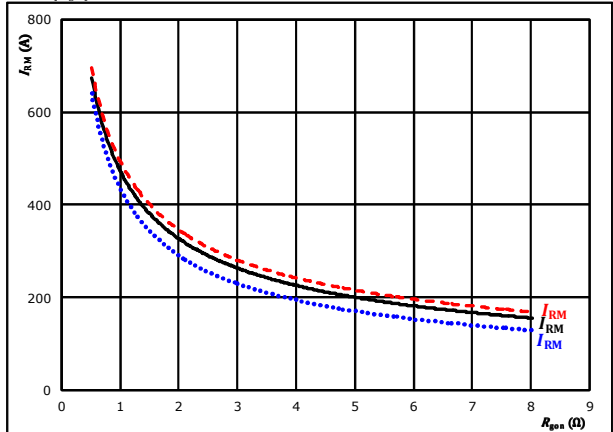


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 1$   $\Omega$   
 $T_j$ : 25 °C (dotted blue)  
125 °C (solid black)  
150 °C (dashed red)

figure 12. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 690$  A  
 $T_j$ : 25 °C (dotted blue)  
125 °C (solid black)  
150 °C (dashed red)



Vincotech

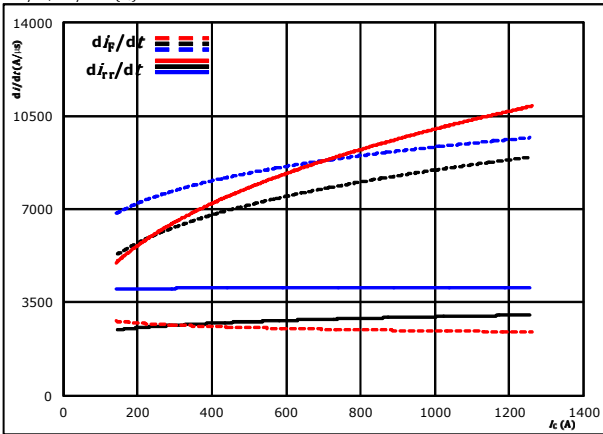
# A0-VS122PA690M7-L750F70 A0-VP122PA690M7-L750F70T

datasheet

## Half-Bridge Switching Characteristics

figure 13. FWD

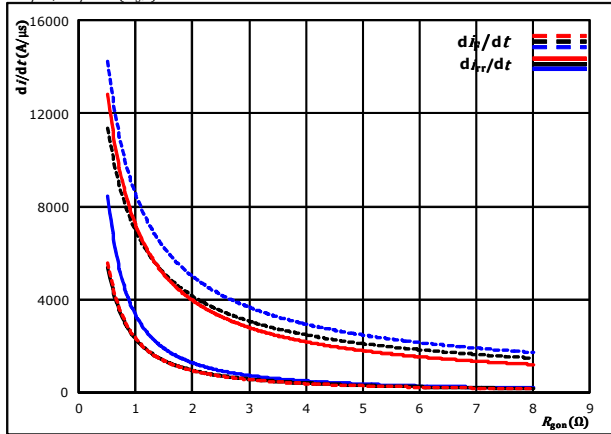
Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_{rr}/dt = f(I_c)$



At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 1$   $\Omega$   
 $T_j = 25$  °C  
 $125$  °C  
 $150$  °C

figure 14. FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor  
 $di_f/dt, di_{rr}/dt = f(R_{gon})$

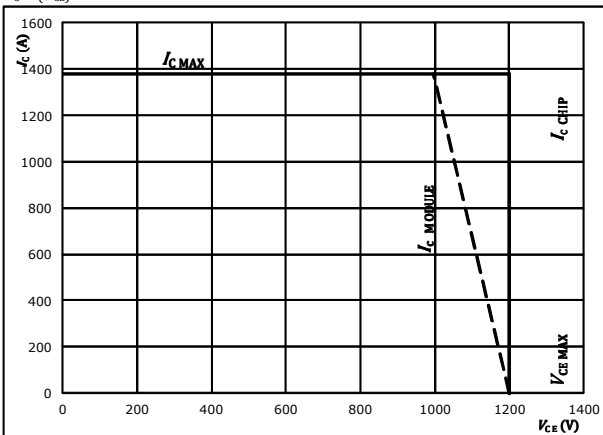


At  $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 690$  A  
 $T_j = 25$  °C  
 $125$  °C  
 $150$  °C

figure 15. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At  $T_j = 175$  °C  
 $R_{gon} = 1$   $\Omega$   
 $R_{goff} = 1$   $\Omega$



Vincotech

# A0-VS122PA690M7-L750F70 A0-VP122PA690M7-L750F70T

datasheet

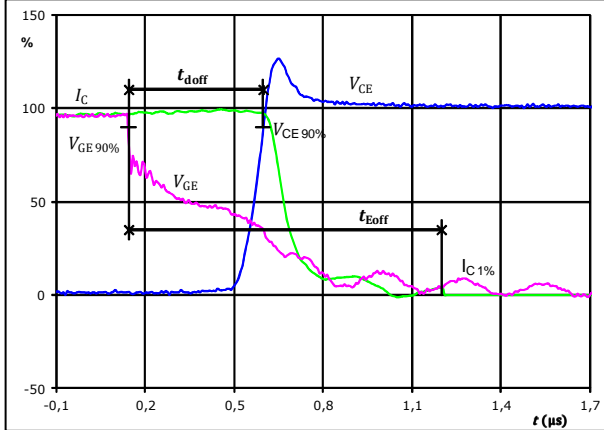
## Half-Bridge Switching Characteristics

General conditions

$T_j$	=	125 °C
$R_{gon}$	=	1 $\Omega$
$R_{goff}$	=	1 $\Omega$

figure 1. IGBT

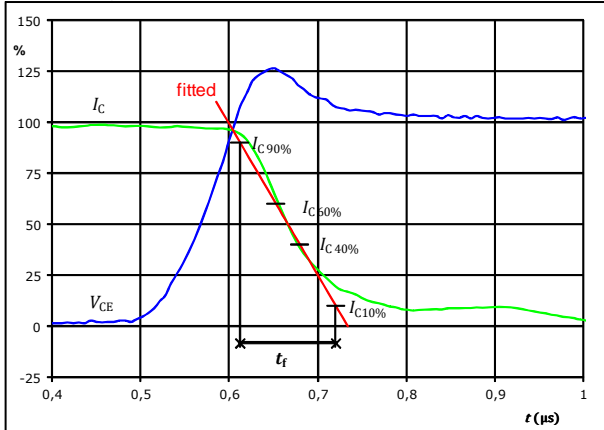
Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$V_{GE}(0\%)$	=	-15	V
$V_{GE}(100\%)$	=	15	V
$V_C(100\%)$	=	600	V
$I_C(100\%)$	=	690	A
$t_{doff}$	=	0,454	$\mu s$
$t_{Eoff}$	=	1,055	$\mu s$

figure 3. IGBT

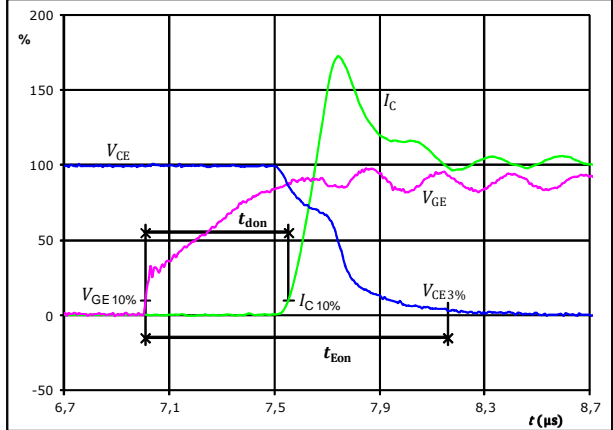
Turn-off Switching Waveforms & definition of  $t_f$



$V_C(100\%)$	=	600	V
$I_C(100\%)$	=	690	A
$t_f$	=	0,088	$\mu s$

figure 2. IGBT

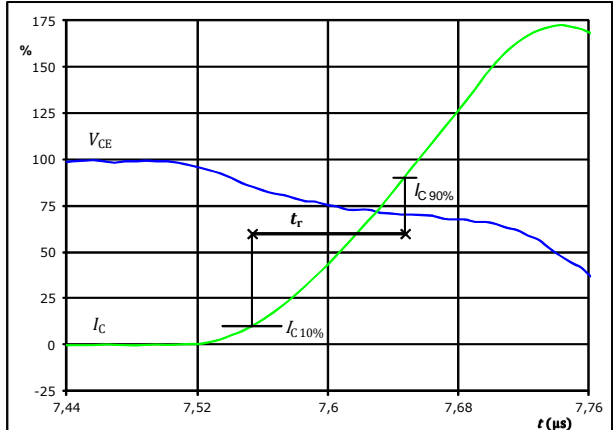
Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



$V_{GE}(0\%)$	=	-15	V
$V_{GE}(100\%)$	=	15	V
$V_C(100\%)$	=	600	V
$I_C(100\%)$	=	690	A
$t_{don}$	=	0,554	$\mu s$
$t_{Eon}$	=	1,151	$\mu s$

figure 4. IGBT

Turn-on Switching Waveforms & definition of  $t_r$



$V_C(100\%)$	=	600	V
$I_C(100\%)$	=	690	A
$t_r$	=	0,093	$\mu s$



Vincotech

# A0-VS122PA690M7-L750F70 A0-VP122PA690M7-L750F70T

datasheet

## Half-Bridge Switching Characteristics

figure 5. IGBT

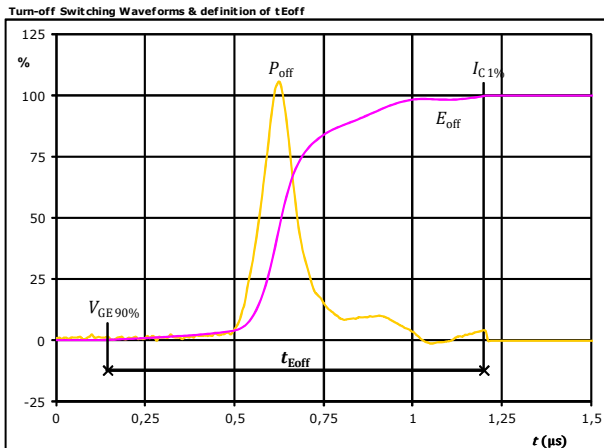


figure 6. IGBT

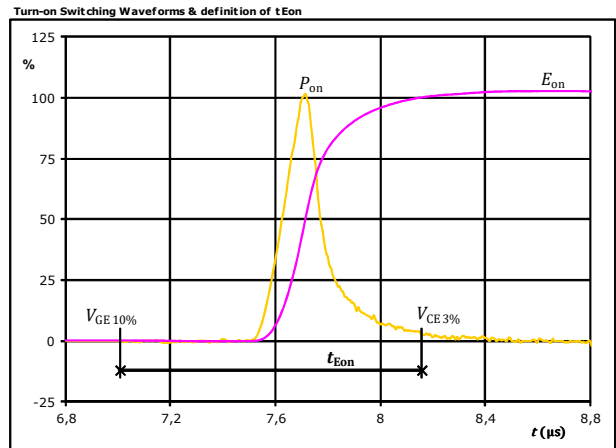
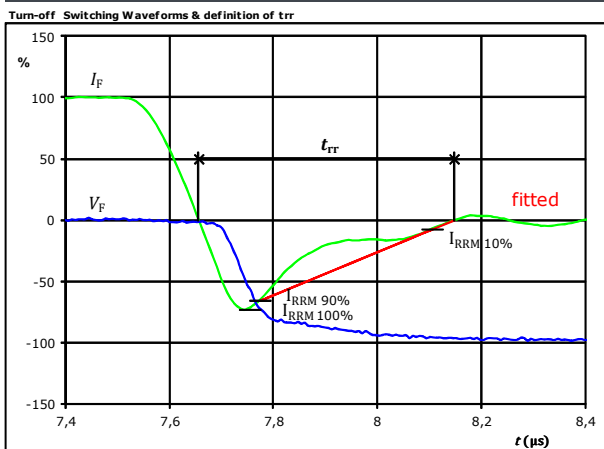


figure 7. FWD



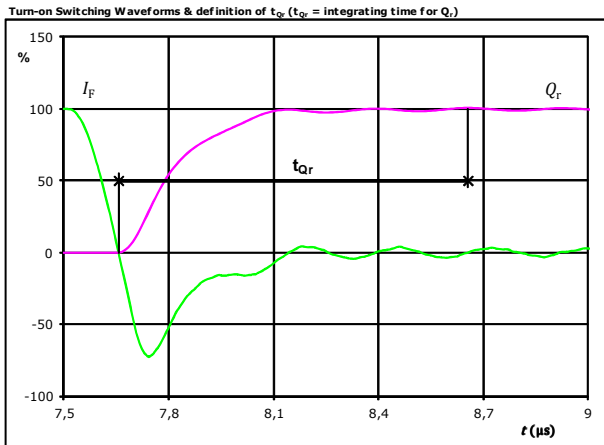


Vincotech

# A0-VS122PA690M7-L750F70 A0-VP122PA690M7-L750F70T datasheet

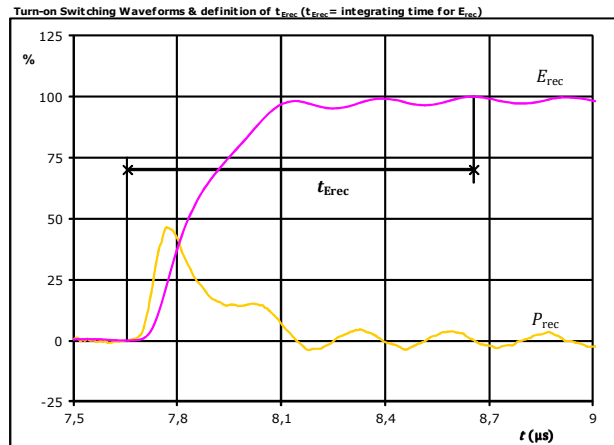
## Half-Bridge Switching Characteristics

figure 8. FWD



$I_F$  (100%) = 690 A  
 $Q_r$  (100%) = 101,14  $\mu\text{C}$   
 $t_{Qr}$  = 1,00  $\mu\text{s}$

figure 9. FWD





$P_{rec}$  (100%) = 414,00 kW  
 $E_{rec}$  (100%) = 41,64 mJ  
 $t_{Erec}$  = 1,00  $\mu\text{s}$



Vincotech

# A0-VS122PA690M7-L750F70 A0-VP122PA690M7-L750F70T

datasheet

Ordering Code & Marking									
Version			Ordering Code						
without thermal paste 17 mm housing with solder pins			A0-VS122PA690M7-L750F70						
with thermal paste 17 mm housing with solder pins			A0-VS122PA690M7-L750F70-/3/						
without thermal paste 17 mm housing with press-fit pins			A0-VP122PA690M7-L750F70T						
with thermal paste 17 mm housing with press-fit pins			A0-VP122PA690M7-L750F70T-/3/						
<div>NN-NNNNNNNNNN-TTTTTTVV VIN WWYY LLLL SSSS</div> <div></div>			Text		Name	Date code	VIN	Lot	Serial
					NN-NNNNNNNNNNNNNN-TTTTTTVV	WWYY	VIN	LLLLL	SSSS
			Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTTVV	LLLLL	SSSS	WWYY					

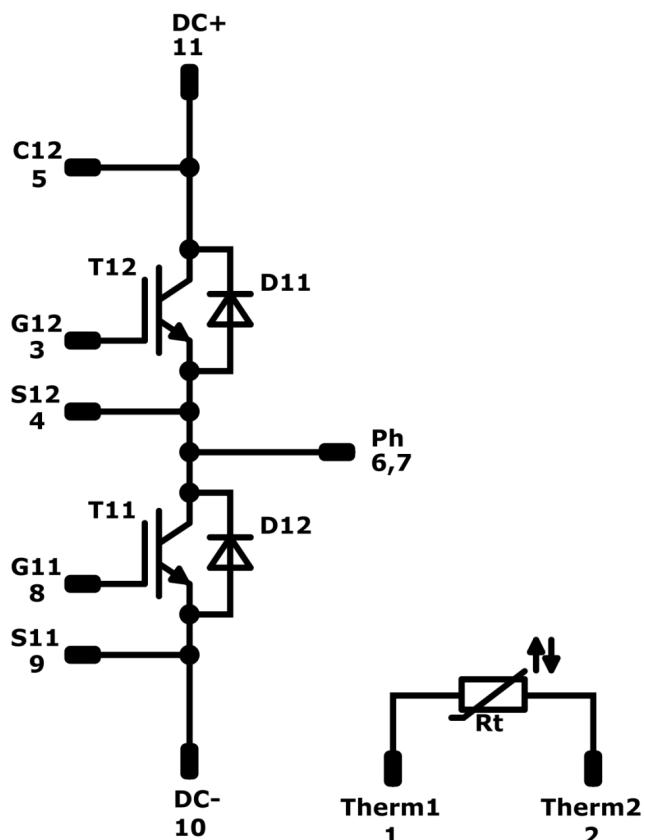
Outline				
Pin table [mm]				
Pin	X	Y	Function	
1	7,24	-0,45	Therm1	
2	11,06	-0,45	Therm2	
3	60,58	-0,45	G12	
4	64,4	-0,45	S12	
5	87,26	-0,45	C12	
6	-	-	Ph	
7	-	-	Ph	
8	37,72	57,95	G11	
9	33,92	57,95	S11	
10	-	-	DC-	
11	-	-	DC+	



Vincotech

**A0-VS122PA690M7-L750F70**  
**A0-VP122PA690M7-L750F70T**  
datasheet

**Pinout**



**Identification**

ID	Component	Voltage	Current	Function	Comment
T11, T12	IGBT	1200 V	690 A	Half-Bridge Switch	
D11, D12	FWD	1200 V	750 A	Half-Bridge Diode	
Rt	NTC			Thermistor	




Vincotech

**A0-VS122PA690M7-L750F70**  
**A0-VP122PA690M7-L750F70T**  
datasheet

Packaging instruction			
Standard packaging quantity (SPQ) 24	>SPQ	Standard	<SPQ Sample

Handling instruction
Handling instructions for VINco E3 packages see vincotech.com website.

Package data
Package data for VINco E3 packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
A0-Vx122PA690M7-L750F70x-D5-14	04 Feb. 2020	Half-Bridge Switch Gate charge value corrected	3

**DISCLAIMER**

The information, specifications, procedures, methods and recommendations herein (together "information") are presented by Vincotech to reader in good faith, are believed to be accurate and reliable, but may well be incomplete and/or not applicable to all conditions or situations that may exist or occur. Vincotech reserves the right to make any changes without further notice to any products to improve reliability, function or design. No representation, guarantee or warranty is made to reader as to the accuracy, reliability or completeness of said information or that the application or use of any of the same will avoid hazards, accidents, losses, damages or injury of any kind to persons or property or that the same will not infringe third parties rights or give desired results. It is reader's sole responsibility to test and determine the suitability of the information and the product for reader's intended use.

**LIFE SUPPORT POLICY**

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.